

E3M0032120J2

Silicon Carbide Power MOSFET
E-Series Automotive
N-Channel Enhancement Mode



Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- 4.7mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

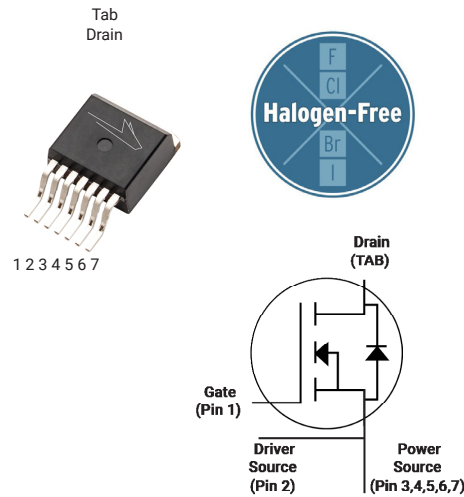
Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Typical Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters

Package



Part Number	Package	Marking
E3M0032120J2	TO-263-7XL	E3M0032120J2

Maximum Ratings ($T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Note
V_{DSmax}	Drain - Source Voltage	1200	V	
V_{GSmax}	Gate - Source Voltage	-8/+19	V	Note: 1
I_D	Continuous Drain Current, $V_{GS} = 15\text{ V}$	$T_c = 25^\circ\text{C}$	74	A Fig. 19 Note: 2
		$T_c = 100^\circ\text{C}$	53	
$I_{D(pulse)}$	Pulsed Drain Current, Pulse width t_p limited by T_{jmax}	156	A	Fig. 22
P_D	Power Dissipation, $T_c=25^\circ\text{C}$, $T_j = 175^\circ\text{C}$	341	W	Fig. 20 Note: 2
T_j, T_{stg}	Operating Junction and Storage Temperature	-55 to +175	$^\circ\text{C}$	
T_L	Solder Temperature, 1.6mm (0.063") from case for 10s	260	$^\circ\text{C}$	

Note (1): Recommended turn off / turn on gate voltage $V_{GS} = -4V...0V / +15V$

Note (2): Verified by design


Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1200			V	$V_{GS} = 0\text{ V}, I_D = 100\text{ }\mu\text{A}$	
$V_{GS(th)}$	Gate Threshold Voltage	1.8	2.9	3.8	V	$V_{DS} = V_{GS}, I_D = 10.7\text{ mA}$	Fig. 11
			2.4		V	$V_{DS} = V_{GS}, I_D = 10.7\text{ mA}, T_J = 175^\circ\text{C}$	
I_{DSS}	Zero Gate Voltage Drain Current		1	50	μA	$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$	
I_{GSS}	Gate-Source Leakage Current		10	250	nA	$V_{GS} = 15\text{ V}, V_{DS} = 0\text{ V}$	
$R_{DS(on)}$	Drain-Source On-State Resistance	23	32	43	m Ω	$V_{GS} = 15\text{ V}, I_D = 38.9\text{ A}$	Fig. 4, 5, 6
			55			$V_{GS} = 15\text{ V}, I_D = 38.9\text{ A}, T_J = 175^\circ\text{C}$	
g_{fs}	Transconductance		23		S	$V_{DS} = 20\text{ V}, I_{DS} = 38.9\text{ A}$	Fig. 7
			22			$V_{DS} = 20\text{ V}, I_{DS} = 38.9\text{ A}, T_J = 175^\circ\text{C}$	
C_{iss}	Input Capacitance		3460		pF	$V_{GS} = 0\text{ V}, V_{DS} = 0\text{ V to }1000\text{ V}$ $f = 100\text{ kHz}$ $V_{AC} = 25\text{ mV}$	Fig. 17, 18
C_{oss}	Output Capacitance		126				
C_{rss}	Reverse Transfer Capacitance		7				
E_{oss}	C_{oss} Stored Energy		71		μJ	$V_{DS} = 1000\text{ V}, f = 100\text{ kHz}$	Fig. 16
$C_{o(er)}$	Effective Output Capacitance (Energy Related)		158		pF	$V_{GS} = 0\text{ V}, V_{DS} = 0\text{ to }800\text{ V}$	Note: 3
$C_{o(tr)}$	Effective Output Capacitance (Time Related)		242		pF		
E_{ON}	Turn-On Switching Energy (Body Diode FWD)		657		μJ	$V_{DS} = 800\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}, I_D = 38.9\text{ A},$ $R_{G(ext)} = 2.5\text{ }\Omega, L = 99\text{ }\mu\text{H}, T_J = 175^\circ\text{C}$ FWD = Internal Body Diode	Fig. 26, 28
E_{OFF}	Turn-Off Switching Energy (Body Diode FWD)		67				
$t_{d(on)}$	Turn-On Delay Time		14		ns	$V_{DD} = 800\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}, I_D = 38.9\text{ A},$ $R_{G(ext)} = 2.5\text{ }\Omega, L = 99\text{ }\mu\text{H}, T_J = 175^\circ\text{C}$ Timing relative to V_{DS} Inductive load	Fig. 27, 28
t_r	Rise Time		19				
$t_{d(off)}$	Turn-Off Delay Time		25				
t_f	Fall Time		8				
$R_{G(int)}$	Internal Gate Resistance		1.1		Ω	$f = 1\text{ MHz}$	
Q_{gs}	Gate to Source Charge		41		nC	$V_{DS} = 800\text{ V}, V_{GS} = -4\text{ V}/15\text{ V}$ $I_D = 38.9\text{ A}$ Per IEC60747-8-4 pg 21	Fig. 12
Q_{gd}	Gate to Drain Charge		27				
Q_g	Total Gate Charge		108				

Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as C_{oss} while V_{ds} is rising from 0 to 800V

$C_{o(tr)}$, a lumped capacitance that gives same charging time as C_{oss} while V_{ds} is rising from 0 to 800V


Reverse Diode Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_{SD}	Diode Forward Voltage	4.9		V	$V_{GS} = -4\text{ V}, I_{SD} = 19.5\text{ A}, T_J = 25^\circ\text{C}$	Fig. 8, 9, 10
		4.3		V	$V_{GS} = -4\text{ V}, I_{SD} = 19.5\text{ A}, T_J = 175^\circ\text{C}$	
I_S	Continuous Diode Forward Current		58	A	$V_{GS} = -4\text{ V}, T_c = 25^\circ\text{C}$	
$I_{S, pulse}$	Diode pulse Current		156	A	$V_{GS} = -4\text{ V}$, pulse width t_p limited by T_{Jmax}	
t_{rr}	Reverse Recover time	12		ns	$V_{GS} = -4\text{ V}, I_{SD} = 38.9\text{ A}, V_R = 800\text{ V}$ $di_F/dt = 8550\text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$	
Q_{rr}	Reverse Recovery Charge	367		nC		
I_{rrm}	Peak Reverse Recovery Current	56		A		
t_{rr}	Reverse Recover time	18		ns	$V_{GS} = -4\text{ V}, I_{SD} = 62.12\text{ A}, V_R = 800\text{ V}$ $di_F/dt = 2305\text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$	
Q_{rr}	Reverse Recovery Charge	191		nC		
I_{rrm}	Peak Reverse Recovery Current	19		A		

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	0.34	0.44	$^\circ\text{C}/\text{W}$		Fig. 21



Typical Performance

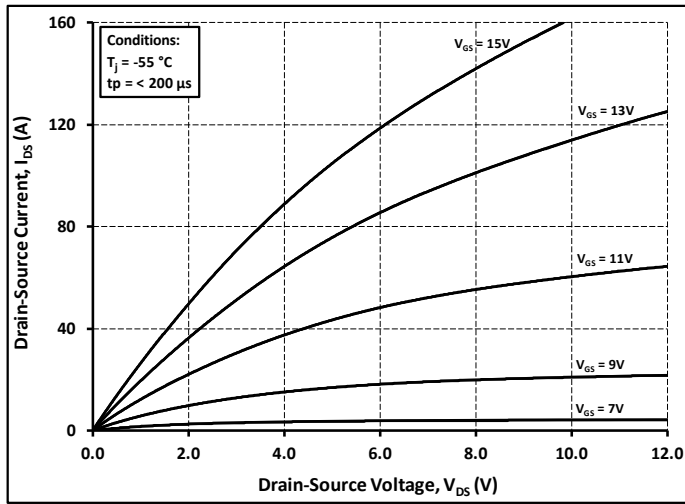


Figure 1. Output Characteristics $T_J = -55\text{ }^{\circ}\text{C}$

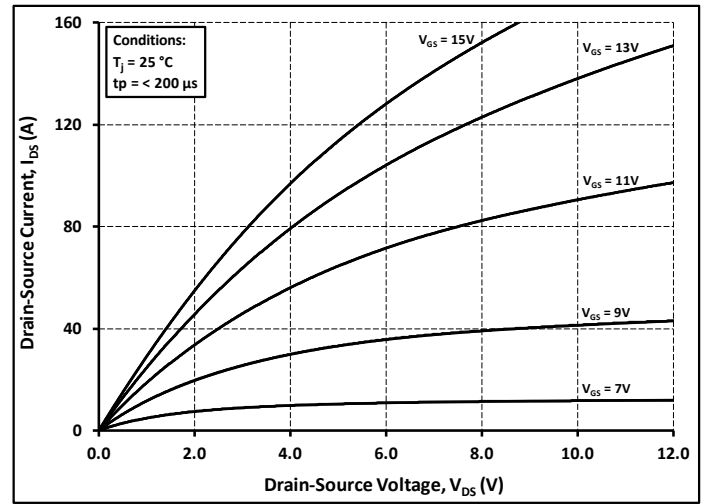


Figure 2. Output Characteristics $T_J = 25\text{ }^{\circ}\text{C}$

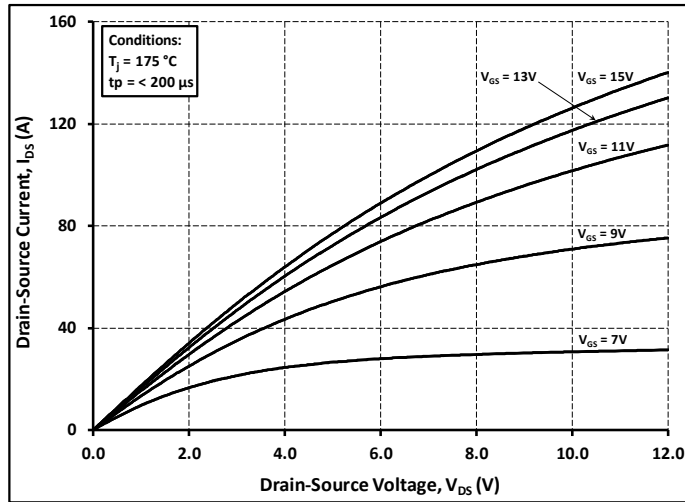


Figure 3. Output Characteristics $T_J = 175\text{ }^{\circ}\text{C}$

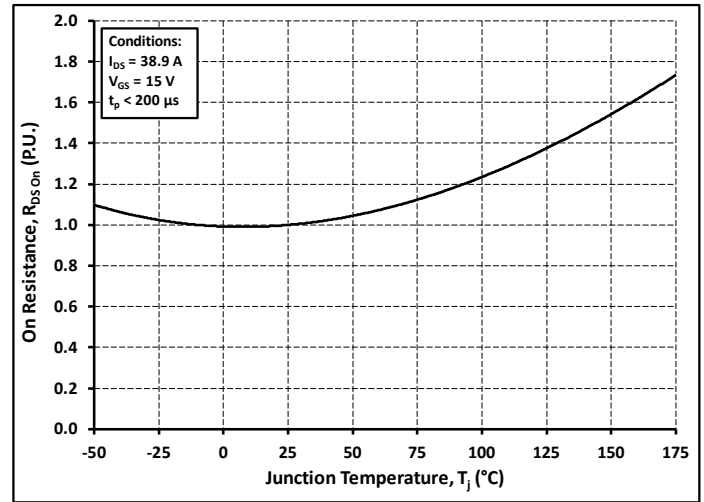


Figure 4. Normalized On-Resistance vs. Temperature

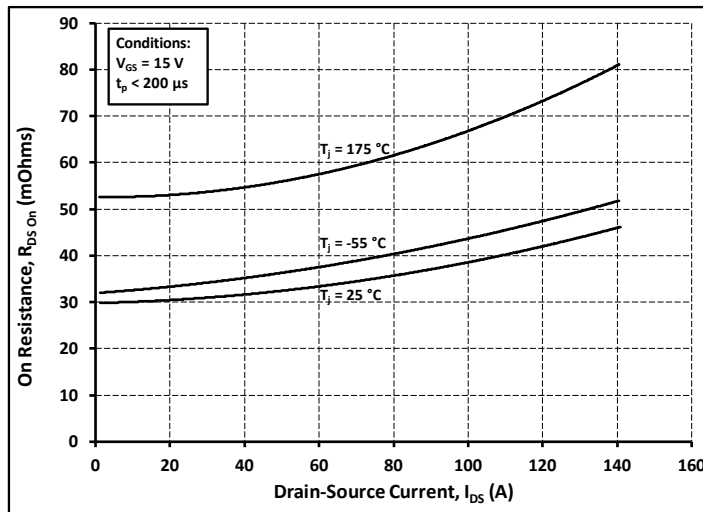


Figure 5. On-Resistance vs. Drain Current
For Various Temperatures

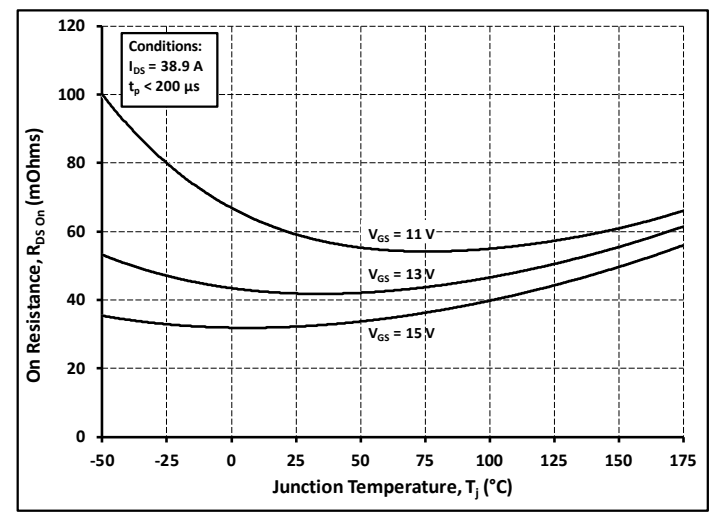


Figure 6. On-Resistance vs. Temperature
For Various Gate Voltage

Typical Performance

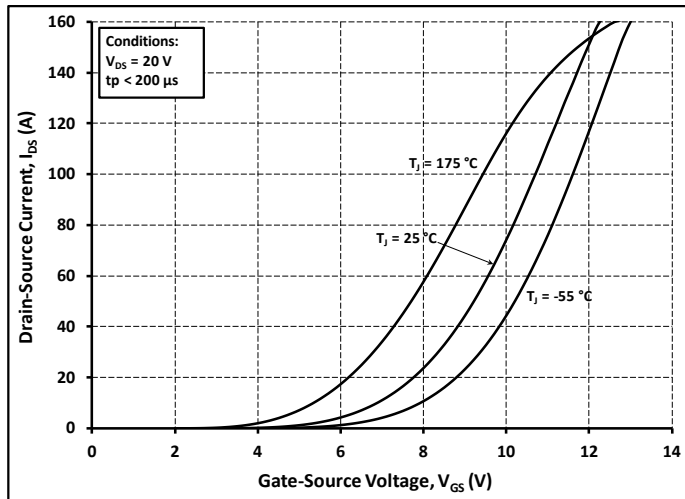


Figure 7. Transfer Characteristic for Various Junction Temperatures

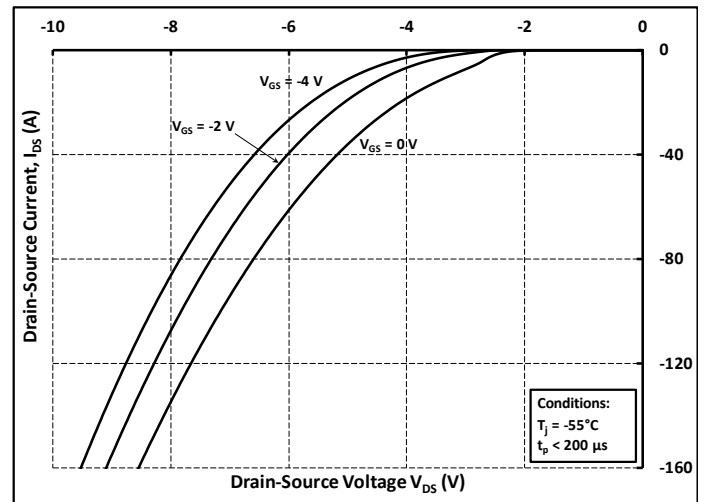


Figure 8. Body Diode Characteristic at -55 °C

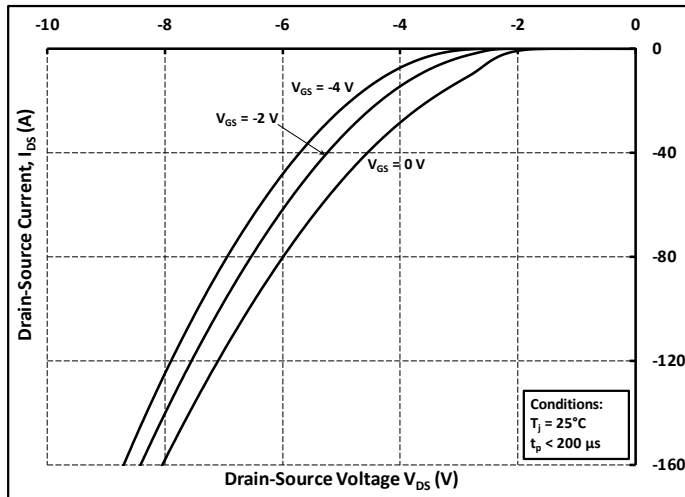


Figure 9. Body Diode Characteristic at 25 °C

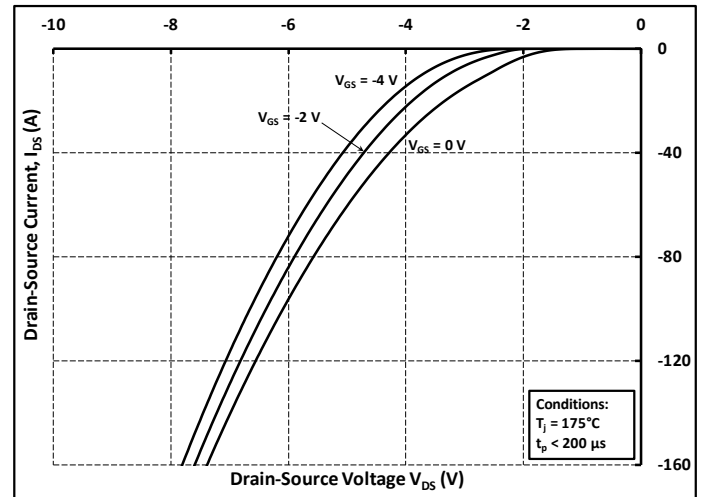


Figure 10. Body Diode Characteristic at 175 °C

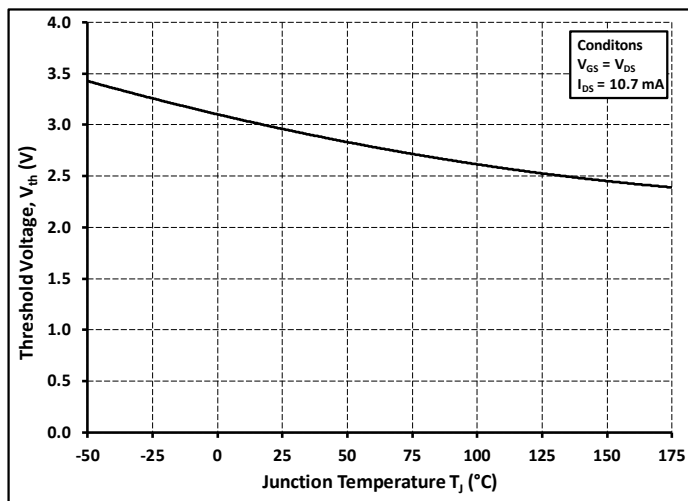


Figure 11. Threshold Voltage vs. Temperature

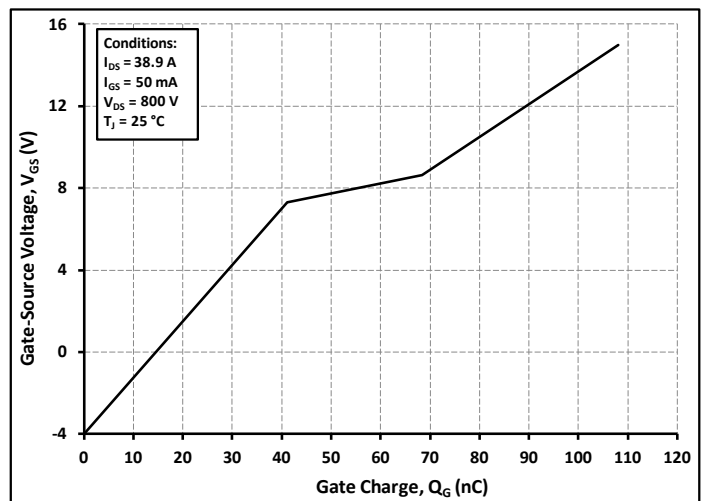


Figure 12. Gate Charge Characteristics

Typical Performance

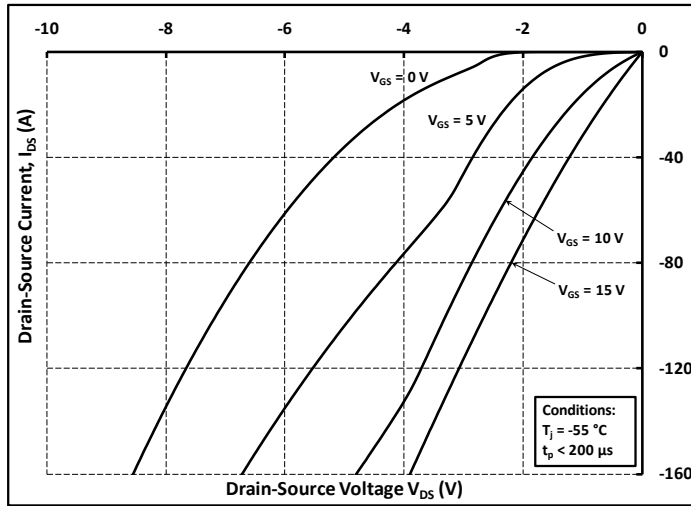
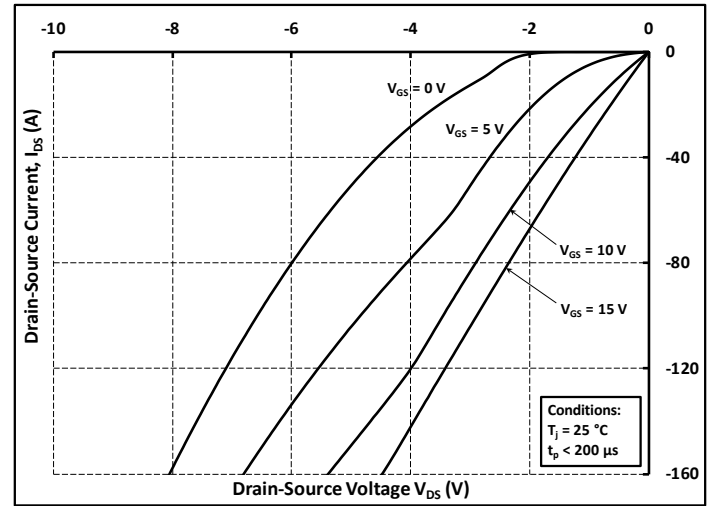
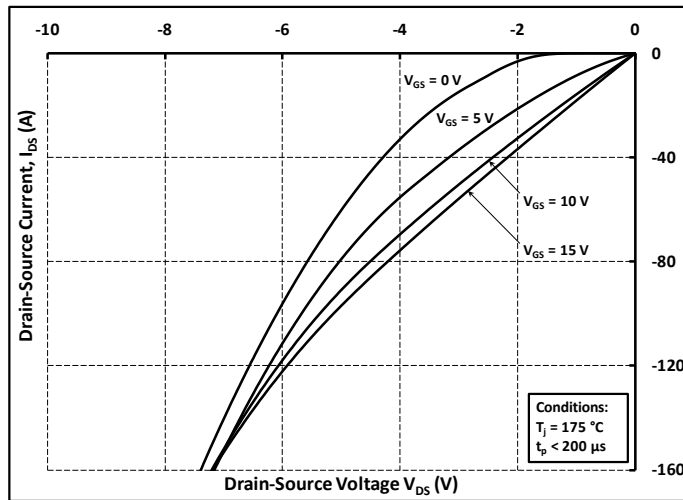
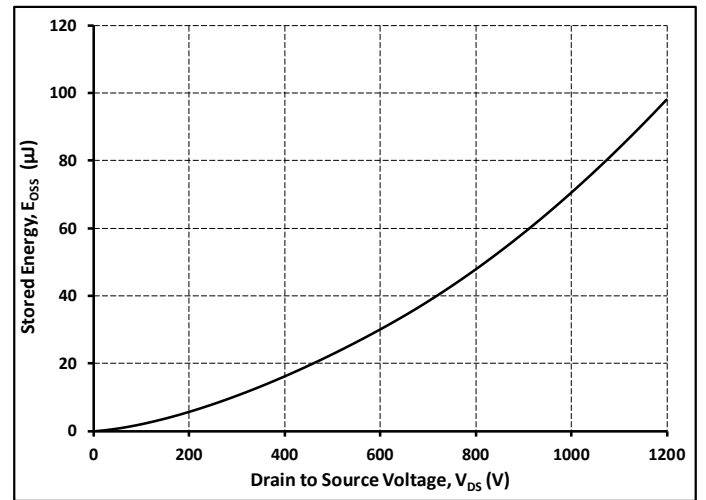
Figure 13. 3rd Quadrant Characteristic at -55°C Figure 14. 3rd Quadrant Characteristic at 25°C Figure 15. 3rd Quadrant Characteristic at 175°C 

Figure 16. Output Capacitor Stored Energy

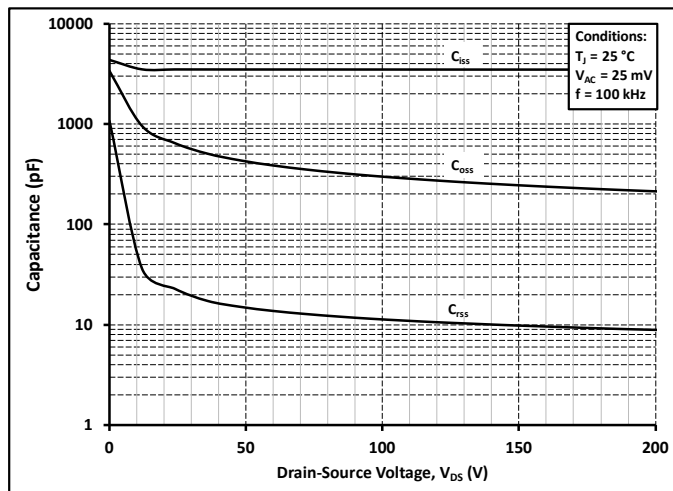


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

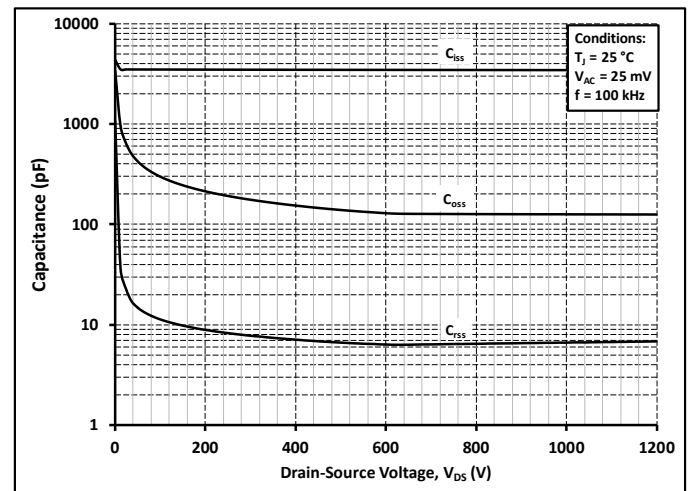


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)

Typical Performance

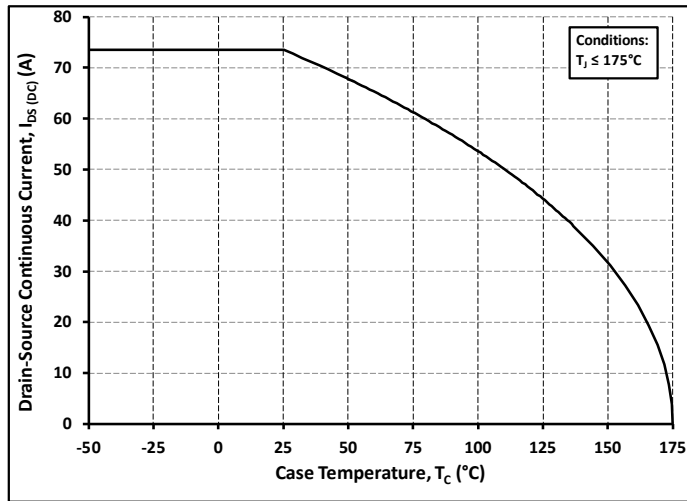


Figure 19. Continuous Drain Current Derating vs. Case Temperature

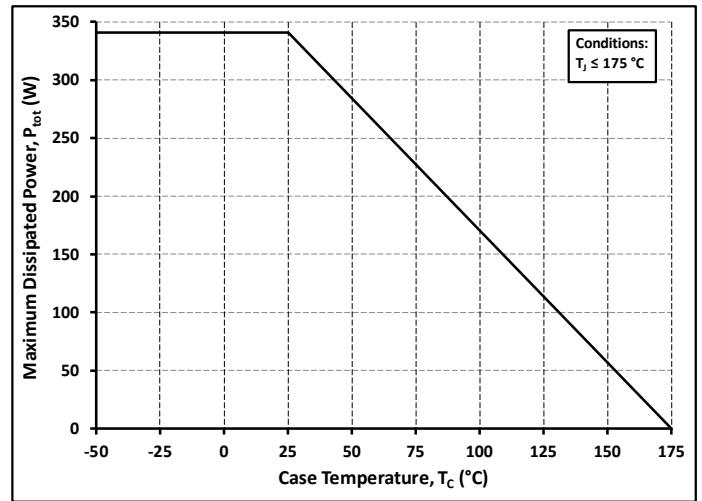


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

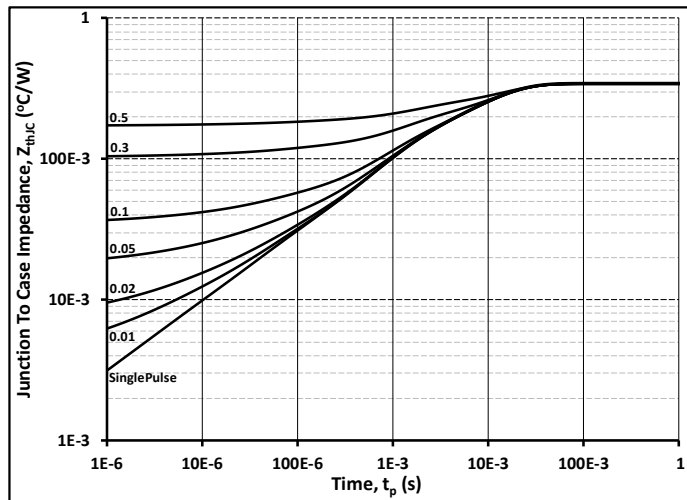


Figure 21. Transient Thermal Impedance (Junction - Case)

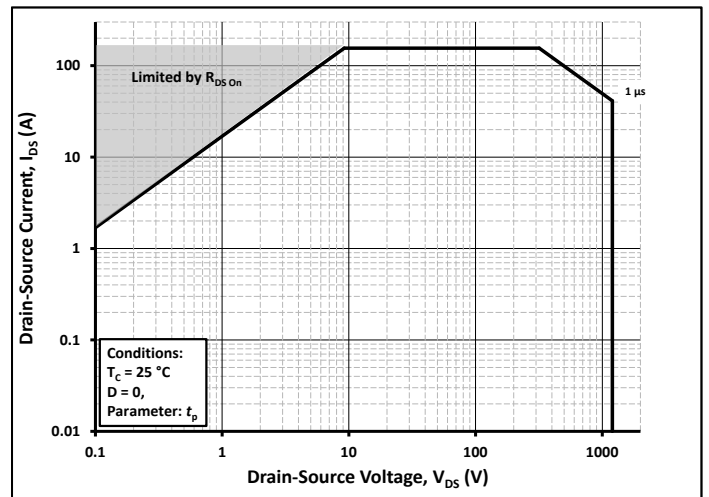
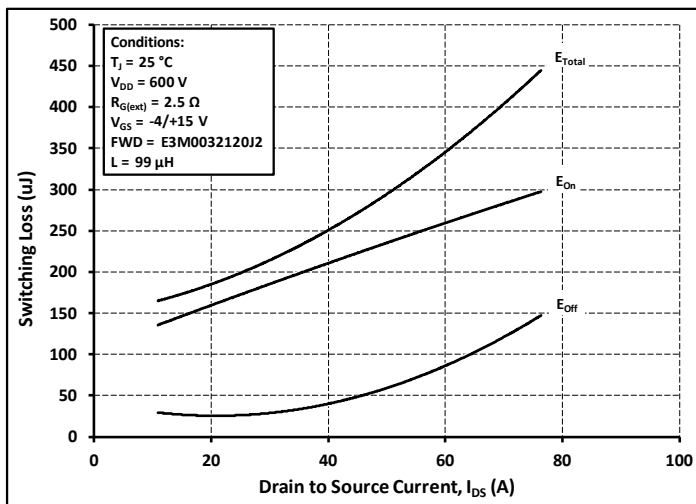
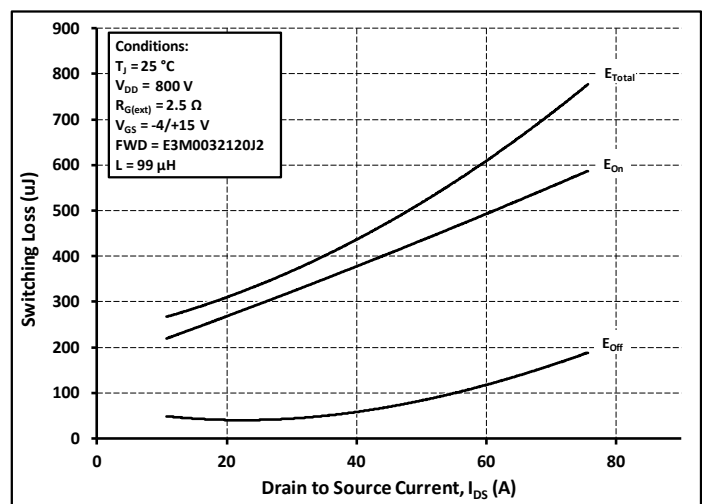


Figure 22. Safe Operating Area

Figure 23. Clamped Inductive Switching Energy vs. Drain Current ($V_{DD} = 600V$)Figure 24. Clamped Inductive Switching Energy vs. Drain Current ($V_{DD} = 800V$)

Typical Performance

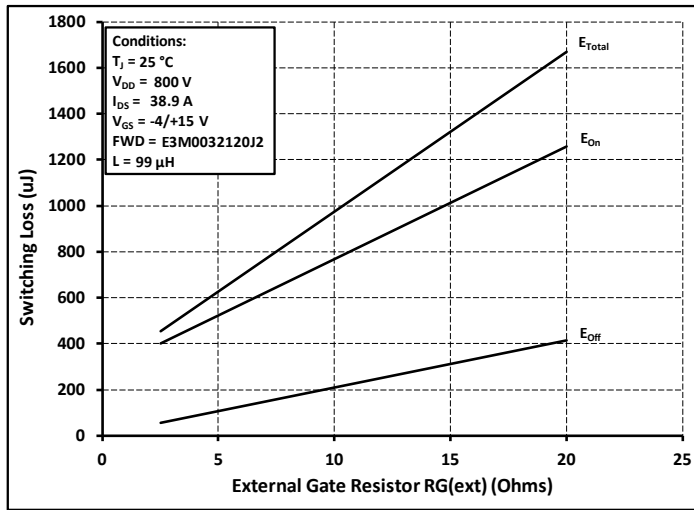
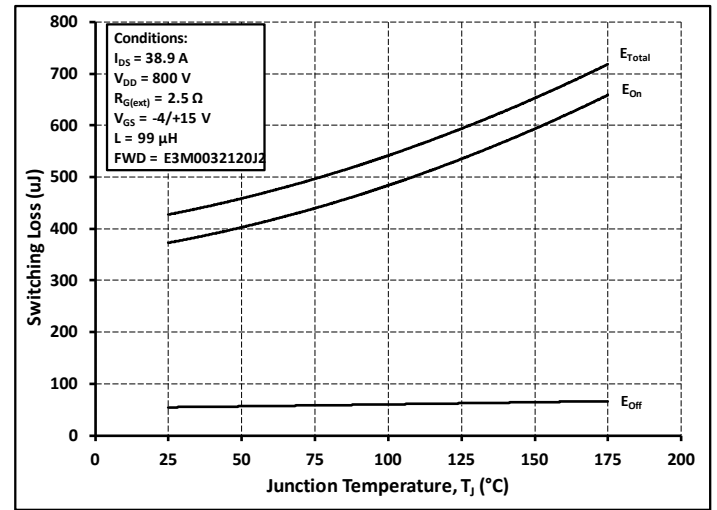
Figure 25. Clamped Inductive Switching Energy vs. $R_{G(\text{ext})}$ 

Figure 26. Clamped Inductive Switching Energy vs. Temperature

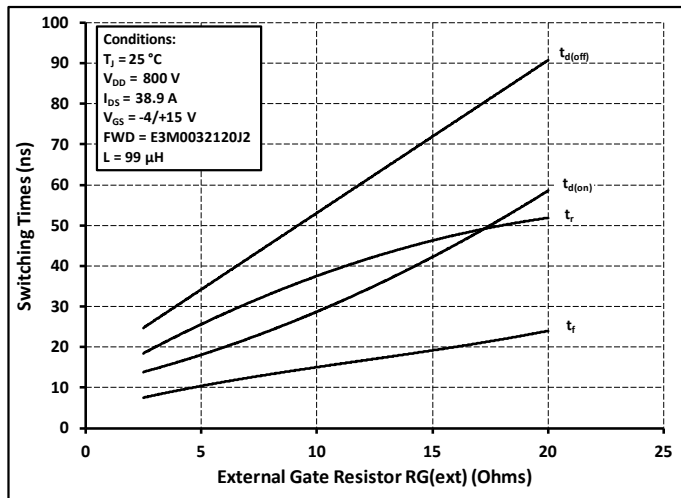
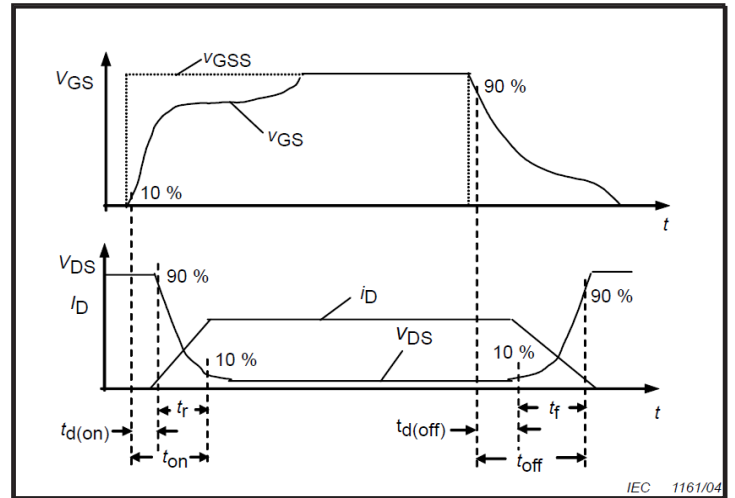
Figure 27. Switching Times vs. $R_{G(\text{ext})}$ 

Figure 28. Switching Times Definition

Test Circuit Schematic

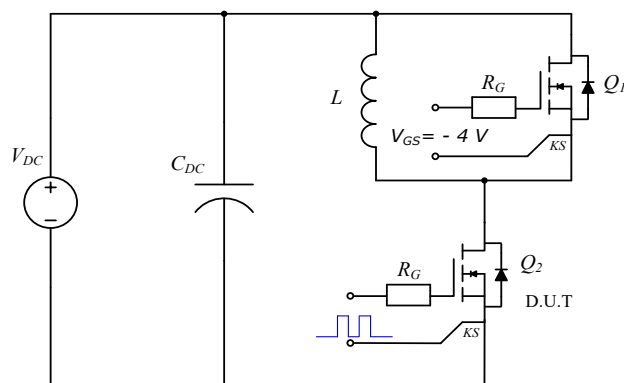
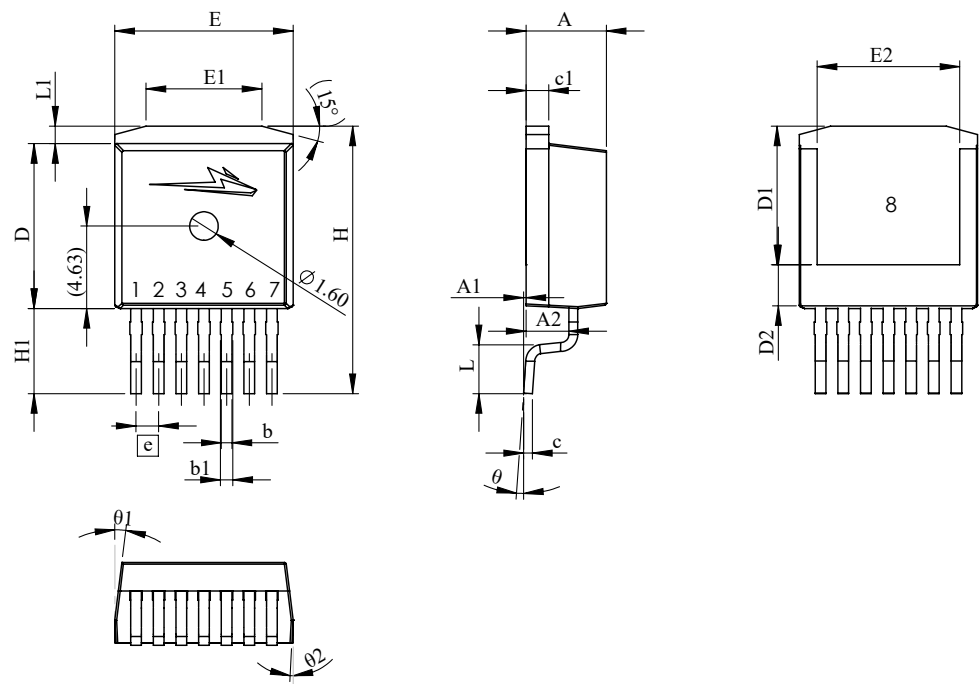


Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



SYMBOL	MIN (mm)	MAX (mm)
A	4.30	4.70
A1	0.00	0.25
A2	2.20	2.60
b	0.52	0.72
b1	0.60	0.80
c	0.42	0.62
c1	1.07	1.47
D	9.05	9.45
D1	7.58	7.98
D2	2.05	2.45
E	9.80	10.20
E1	6.30	6.97
E2	7.80	8.20
e	1.27 BSC	
H	14.87	15.27
H1	4.55	4.95
L	2.48	2.88
L1	0.87	1.27
θ	0°	8°
θ1	4°	10°
θ2	0°	6°

1	GATE
2	KELVIN
3	SOURCE
4	
5	
6	
7	DRAIN
8	

NOTE

1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
4. PACKAGE BURR FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS





Revision history

Document Version	Date of release	Descriptiion of changes
1.0	December 2023	Initial release
2	January - 2025	Legal Disclaimer updated
3	March - 2025	Removed V_{AC} from $R_{G(int)}$ test condition Updated Fig 22



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